

LOW DROP OR-ing POWER SCHOTTKY RECTIFIER

MAIN PRODUCT CHARACTERISTICS

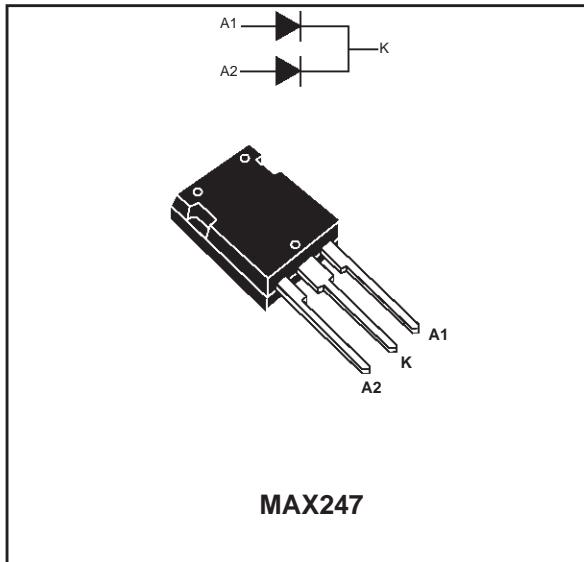
$I_{F(AV)}$	2 x 40 A
V_{RRM}	15 V
$T_j(\max)$	125 °C
$V_F(\max)$	0.33 V

FEATURES AND BENEFITS

- VERY LOW DROP FORWARD VOLTAGE FOR LESS POWER DISSIPATION AND REDUCED HEATSINK
- OPTIMIZED CONDUCTION AND REVERSE LOSSES TRADE-OFF WHICH MEANS THE HIGHEST EFFICIENCY IN THE EQUIPMENTS

DESCRIPTION

The STPS80L15CY utilizes proprietary barrier technology to optimize forward voltage drop for OR-ing functions in n-1 fault tolerant Switch Mode Power Supplies.



ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			15	V
$I_{F(RMS)}$	RMS forward current			60	A
$I_{F(AV)}$	Average forward current	$T_c = 105^\circ\text{C}$	Per diode $\delta = 0.5$	40 80	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal}$		600	A
I_{IRR}	Repetitive peak reverse current	$t_p = 2 \mu\text{s } F = 1\text{kHz square}$		2	A
T_{stg}	Storage temperature range				-55 to +150 °C
T_j	Maximum operating junction temperature				125 °C
dV/dt	Critical rate of rise of reverse voltage				10000 V/μs

STPS80L15CY

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th} (j-c)	Junction to case	Per diode	0.7
		Total	0.4
R _{th} (c)		Coupling	0.1

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{\text{th(j-c)}}(\text{Per diode}) + P(\text{diode 2}) \times R_{\text{th(c)}}$$

STATIC ELECTRICAL CHARACTERISTICS (per diode)

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I _R *	Reverse leakage current	T _j = 25°C	V _R = 5V			4	mA
		T _j = 100°C			210	400	
		T _j = 25°C	V _R = 12V			6	
		T _j = 100°C			310	600	
V _F **	Forward voltage drop	T _j = 25°C	I _F = 40 A			0.43	V
		T _j = 100°C	I _F = 40 A		0.28	0.33	
		T _j = 25°C	I _F = 80 A			0.53	
		T _j = 100°C	I _F = 80 A		0.42	0.47	

Pulse test : * tp = 5 ms, δ < 2 %

** tp = 380 μs, δ < 2%

To evaluate the maximum conduction losses use the following equation :

$$P = 0.19 \times I_{F(\text{AV})} + 0.0035 \times I_{F(\text{RMS})}^2$$

Fig. 1: Average forward power dissipation versus average forward current (per diode).

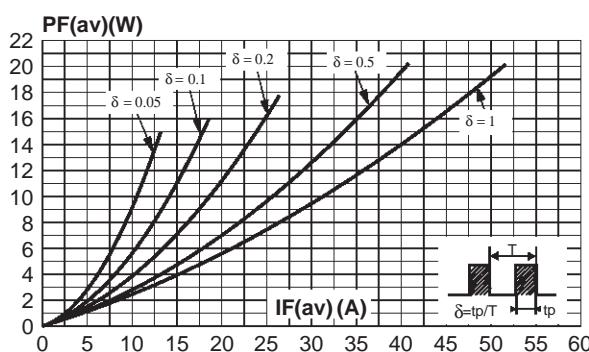


Fig. 2: Average forward current versus ambient temperature ($\delta=0.5$, per diode).

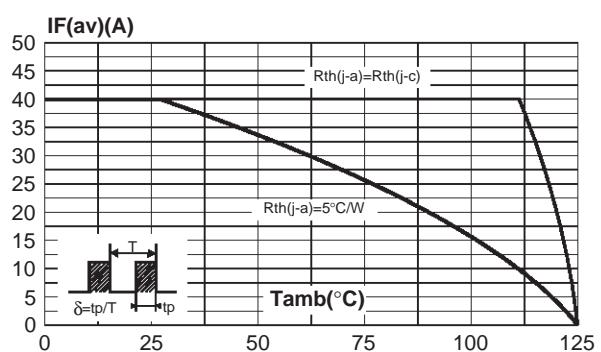


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values, per diode).

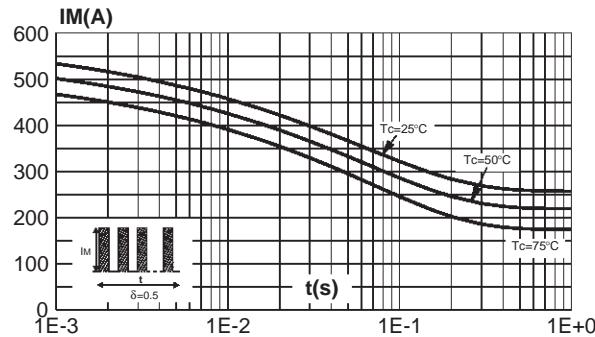


Fig. 4: Relative variation of thermal impedance junction to case versus pulse (per diode).

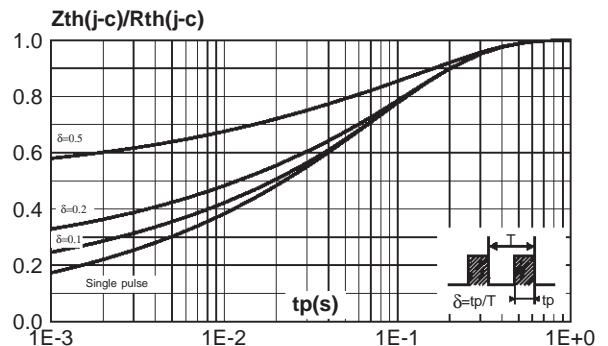


Fig. 5: Reverse leakage current versus reverse voltage applied (typical values, per diode).

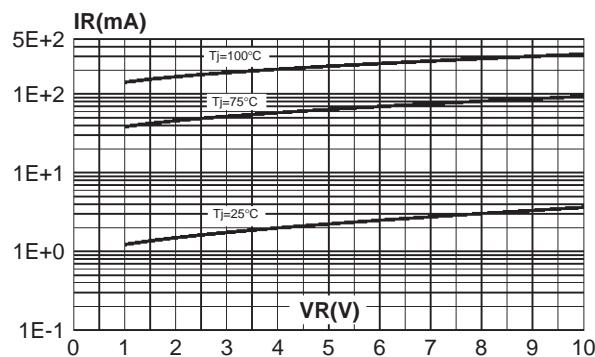


Fig. 6: Junction capacitance versus reverse voltage applied (typical values, per diode).

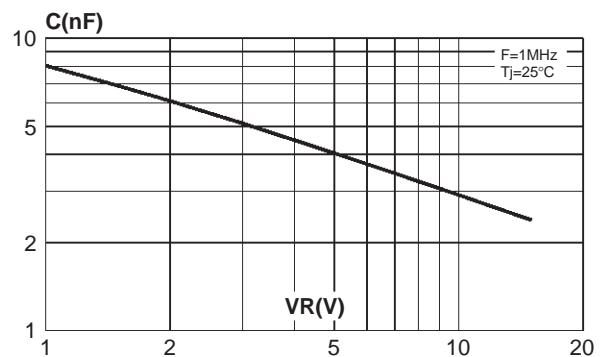
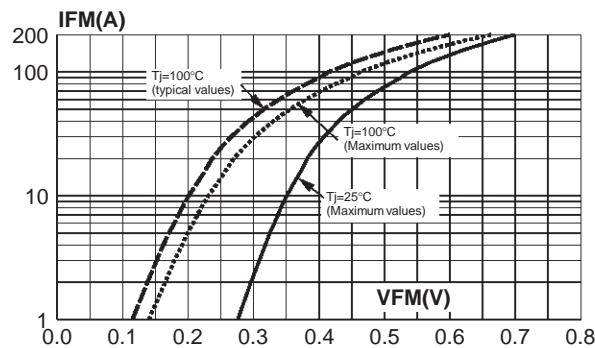


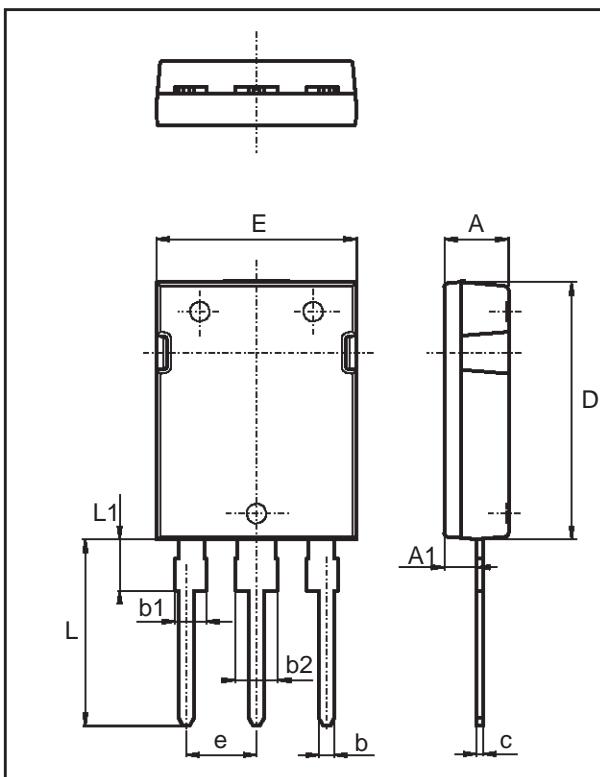
Fig. 7: Forward voltage drop versus forward current (per diode).



STPS80L15CY

PACKAGE MECHANICAL DATA

MAX247



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.70	5.30	0.185	0.209
A1	2.20	2.60	0.087	0.102
b	1.00	1.40	0.038	0.055
b1	2.00	2.40	0.079	0.094
b2	3.00	3.40	0.118	0.133
c	0.40	0.80	0.016	0.031
D	19.70	10.30	0.776	0.799
e	5.35	5.55	0.211	0.219
E	15.30	15.90	0.602	0.626
L	14.20	15.20	0.559	0.598
L1	3.70	4.30	0.146	0.169

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS80L15CY	STPS80L15CY	MAX247	5g	30	Tube

■ Epoxy meets UL94,V0

■ Cooling method: C

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